



## Description

### JMT N-channel Enhancement Mode Power MOSFET

#### Features

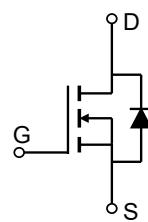
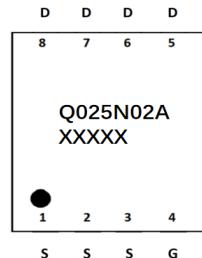
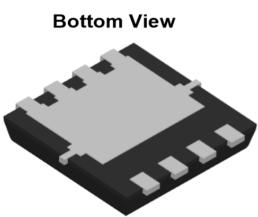
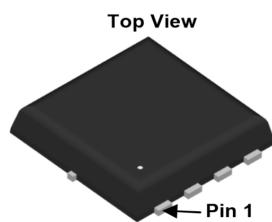
- 20V, 80A
- $R_{DS(ON)} < 2.7\text{m}\Omega @ V_{GS} = 10\text{V}$
- $R_{DS(ON)} < 3.0\text{m}\Omega @ V_{GS} = 4.5\text{V}$
- $R_{DS(ON)} < 4.2\text{m}\Omega @ V_{GS} = 2.5\text{V}$
- Advanced Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge

#### Applications

- Load Switch
- PWM Application
- Power Management



100% UIS TESTED!  
100%  $\Delta V_{ds}$  TESTED!



PDFN3x3-8L

Marking and Pin Assignment

Schematic Diagram

#### Package Marking and Ordering Information

| Device Marking | Device      | Outline | Package    | Reel Size | Reel(pcs) | Per Carton (pcs) |
|----------------|-------------|---------|------------|-----------|-----------|------------------|
| Q025N02A       | JMTQ025N02A | TAPING  | PDFN3x3-8L | 13"       | 5000      | 50000            |

#### Absolute Maximum Ratings (@ $T_C = 25^\circ\text{C}$ unless otherwise specified)

| Symbol          | Parameter  |                           | Value      | Units                     |
|-----------------|--|---------------------------|------------|---------------------------|
| $V_{DS}$        | Drain-to-Source Voltage                                |                           | 20         | V                         |
| $V_{GS}$        | Gate-to-Source Voltage                                 |                           | $\pm 12$   | V                         |
| $I_D$           | Continuous Drain Current                               | $T_C = 25^\circ\text{C}$  | 80         | A                         |
|                 |  | $T_C = 100^\circ\text{C}$ | 51         |                           |
| $I_{DM}$        | Pulsed Drain Current <sup>(1)</sup>                    |                           | 320        | A                         |
| $E_{AS}$        | Single Pulsed Avalanche Energy <sup>(2)</sup>          |                           | 210        | mJ                        |
| $P_D$           | Power Dissipation                                      | $T_C = 25^\circ\text{C}$  | 142        | W                         |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient <sup>(3)</sup> |                           | 40         | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case                   |                           | 0.88       |                           |
| $T_J, T_{STG}$  | Junction & Storage Temperature Range                   |                           | -55 to 150 | $^\circ\text{C}$          |



JMTQ025N02A

**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

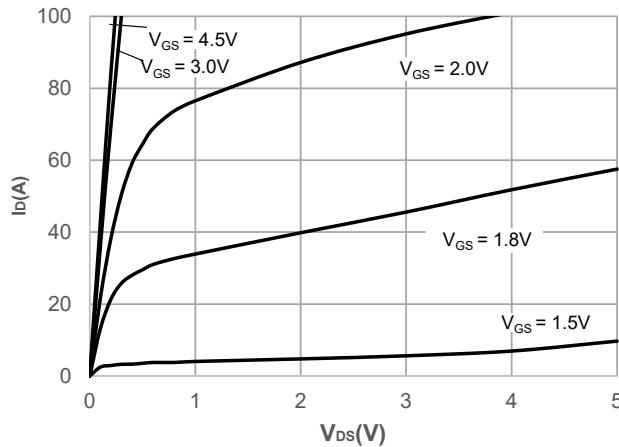
| Symbol  | Parameter  | Conditions   | Min. | Typ. | Max.      | Unit             |
|---|--|--|------|------|-----------|------------------|
| <b>Off Characteristics</b>                                |  |  |      |      |           |                  |
| $V_{(\text{BR})\text{DSS}}$                               | Drain-Source Breakdown Voltage                           | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$   | 20   | -    | -         | V                |
| $I_{\text{DSS}}$  | Zero Gate Voltage Drain Current                          | $V_{DS} = 20\text{V}, V_{GS} = 0\text{V}$  | -    | -    | 1.0       | $\mu\text{A}$    |
| $I_{\text{GSS}}$  | Gate-Body Leakage Current                                | $V_{DS} = 0\text{V}, V_{GS} = \pm 12\text{V}$  | -    | -    | $\pm 100$ | nA               |
| <b>On Characteristics</b>                                 |  |  |      |      |           |                  |
| $V_{GS(\text{th})}$                                       | Gate Threshold Voltage                                   | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$  | 0.6  | 0.95 | 1.3       | V                |
| $R_{\text{DS(ON)}}$                                       | Static Drain-Source ON-Resistance <sup>(4)</sup>         | $V_{GS} = 10\text{V}, I_D = 30\text{A}$  | -    | 2.1  | 2.7       | $\text{m}\Omega$ |
|   |  | $V_{GS} = 4.5\text{V}, I_D = 20\text{A}$   | -    | 2.3  | 3.0       | $\text{m}\Omega$ |
|   |  | $V_{GS} = 2.5\text{V}, I_D = 10\text{A}$   | -    | 3.2  | 4.2       | $\text{m}\Omega$ |
| <b>Dynamic Characteristics</b>                            |  |  |      |      |           |                  |
| $C_{\text{iss}}$  | Input Capacitance  | $V_{GS} = 0\text{V}, V_{DS} = 10\text{V}, f = 1\text{MHz}$                                 | -    | 6215 | -         | pF               |
| $C_{\text{oss}}$  | Output Capacitance                                       |  | -    | 824  | -         | pF               |
| $C_{\text{rss}}$  | Reverse Transfer Capacitance                             |  | -    | 723  | -         | pF               |
| $Q_g$   | Total Gate Charge  | $V_{GS} = 0 \text{ to } 4.5\text{V}$<br>$V_{DS} = 10\text{V}, I_D = 30\text{A}$            | -    | 64   | -         | nC               |
| $Q_{gs}$  | Gate Source Charge                                       |  | -    | 12   | -         | nC               |
| $Q_{gd}$  | Gate Drain("Miller") Charge                              |  | -    | 19   | -         | nC               |
| <b>Switching Characteristics</b>                          |  |  |      |      |           |                  |
| $t_{d(on)}$   | Turn-On Delay Time                                       | $V_{GS} = 10\text{V}, V_{DD} = 10\text{V}$<br>$I_D = 30\text{A}, R_{\text{GEN}} = 3\Omega$ | -    | 20   | -         | ns               |
| $t_r$   | Turn-On Rise Time  |  | -    | 47   | -         | ns               |
| $t_{d(off)}$  | Turn-Off Delay Time                                      |  | -    | 117  | -         | ns               |
| $t_f$   | Turn-Off Fall Time                                       |  | -    | 120  | -         | ns               |
| <b>Drain-Source Diode Characteristics and Max Ratings</b> |  |  |      |      |           |                  |
| $I_S$   | Maximum Continuous Drain to Source Diode Forward Current | -  | -    | 80   | -         | A                |
| $I_{SM}$  | Maximum Pulsed Drain to Source Diode Forward Current     | -  | -    | 320  | -         | A                |
| $V_{SD}$  | Drain to Source Diode Forward Voltage                    | $V_{GS} = 0\text{V}, I_S = 30\text{A}$   | -    | -    | 1.2       | V                |
| $trr$   | Body Diode Reverse Recovery Time                         | $I_F = 20\text{A}, di/dt = 100\text{A/us}$   | -    | 22   | -         | ns               |
| $Qrr$   | Body Diode Reverse Recovery Charge                       |  | -    | 12   | -         | nC               |

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

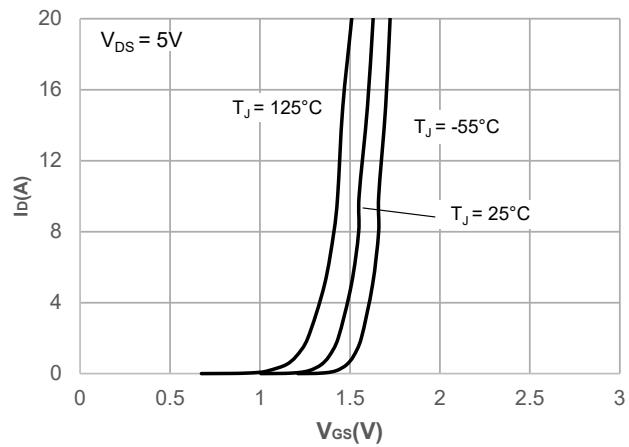
2.  $E_{AS}$  condition: Starting  $T_J=25^\circ\text{C}$ ,  $V_{DD}=10\text{V}$ ,  $V_G=10\text{V}$ ,  $R_G=25\text{ohm}$ ,  $L=0.5\text{mH}$ ,  $I_{AS}=29\text{A}$ 3.  $R_{\theta JA}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB4. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

## Typical Performance Characteristics

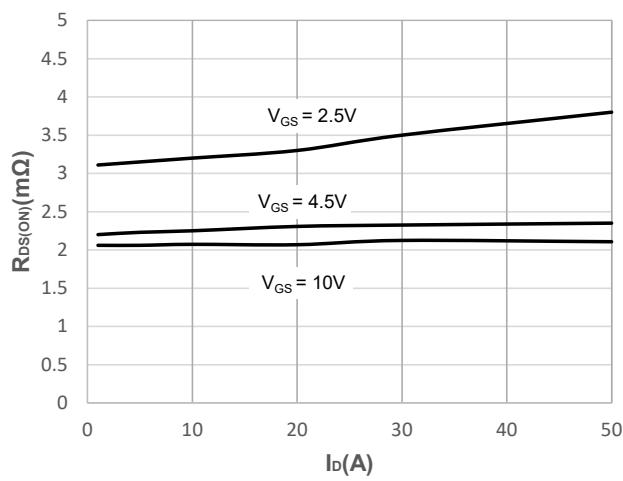
**Figure 1: Output Characteristics**



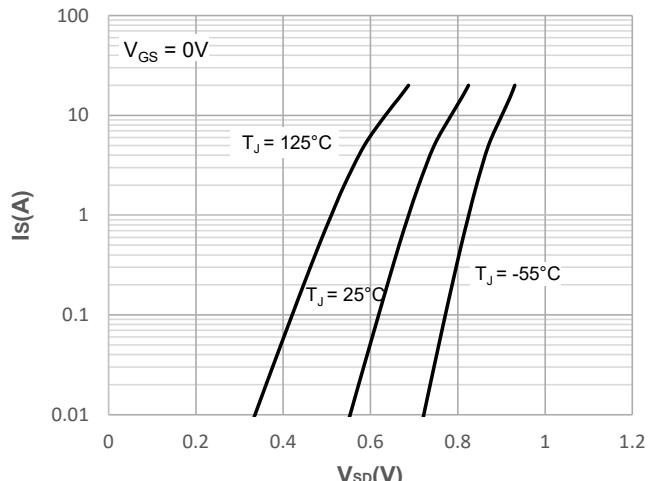
**Figure 2: Typical Transfer Characteristics**



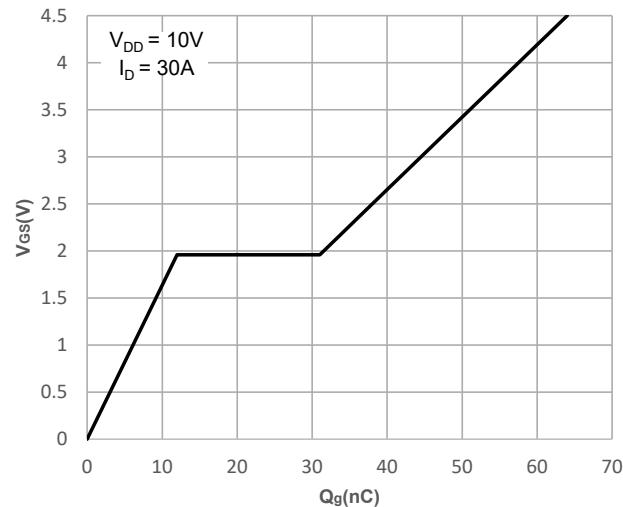
**Figure 3: On-resistance vs. Drain Current**



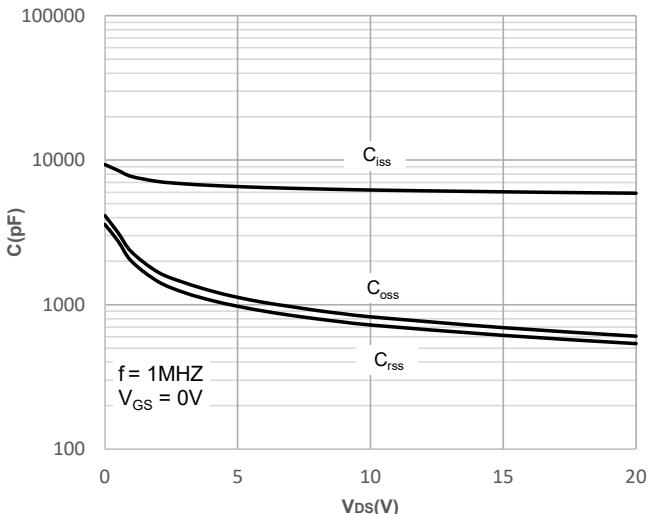
**Figure 4: Body Diode Characteristics**



**Figure 5: Gate Charge Characteristics**

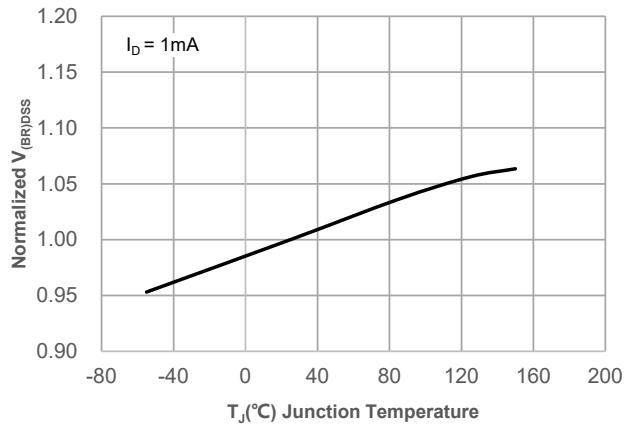


**Figure 6: Capacitance Characteristics**

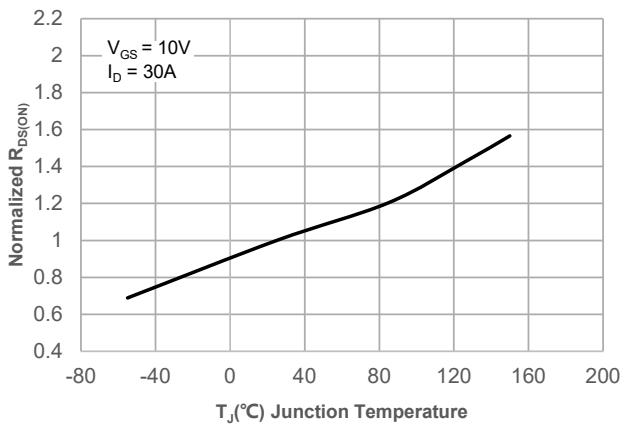


## Typical Performance Characteristics

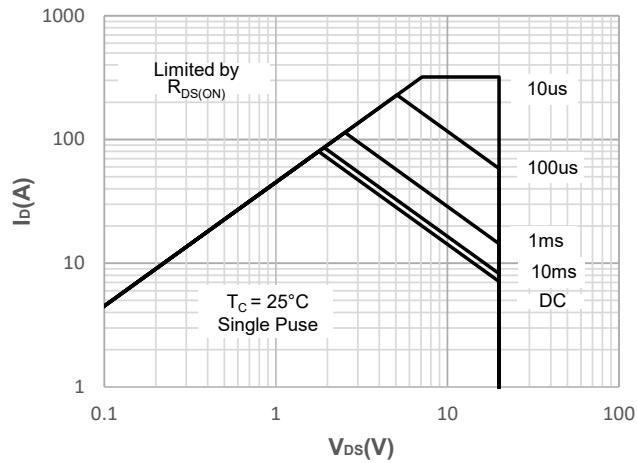
**Figure 7: Normalized Breakdown voltage vs. Junction Temperature**



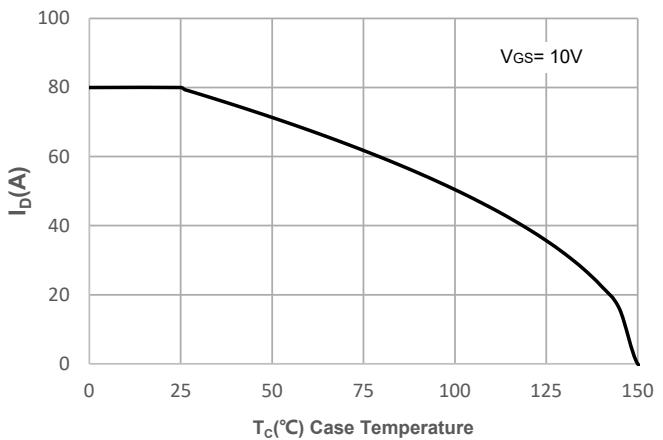
**Figure 8: Normalized on Resistance vs. Junction Temperature**



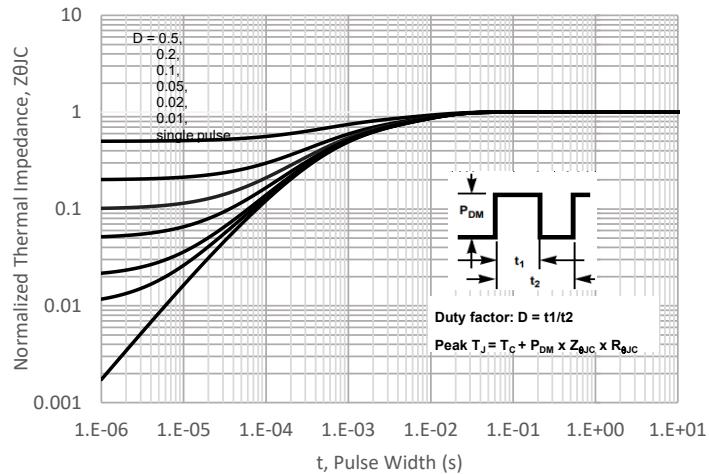
**Figure 9: Maximum Safe Operating Area**



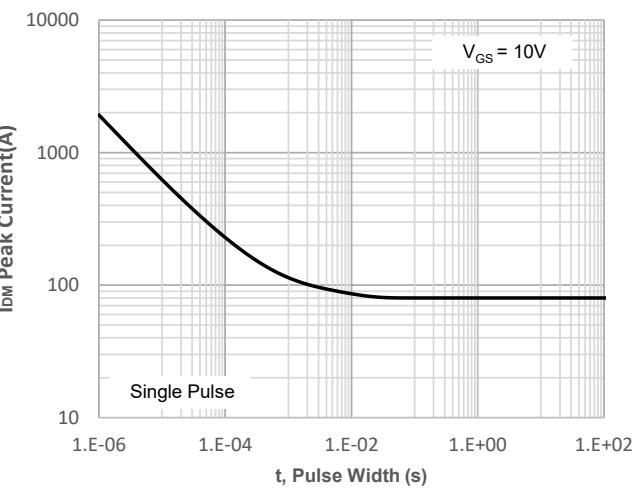
**Figure 10: Maximum Continuous Drian Current vs. Case Temperature**



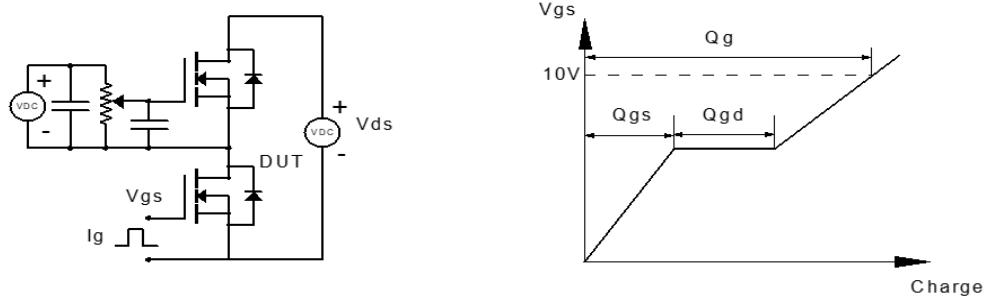
**Figure 11: Normalized Maximum Transient Thermal Impedance**



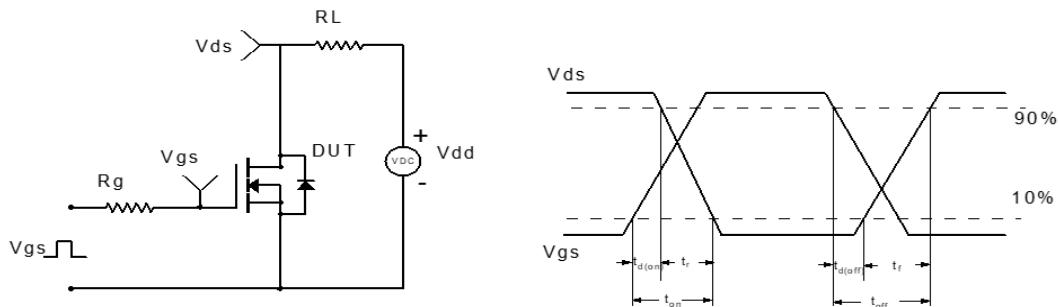
**Figure 12: Peak Current Capacity**



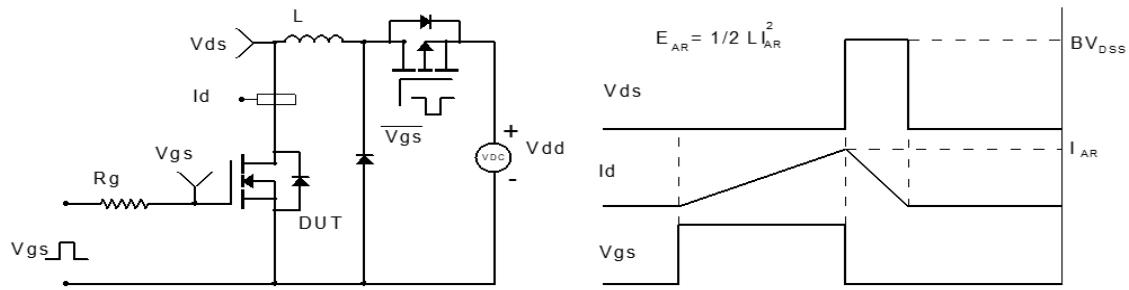
# Test Circuit



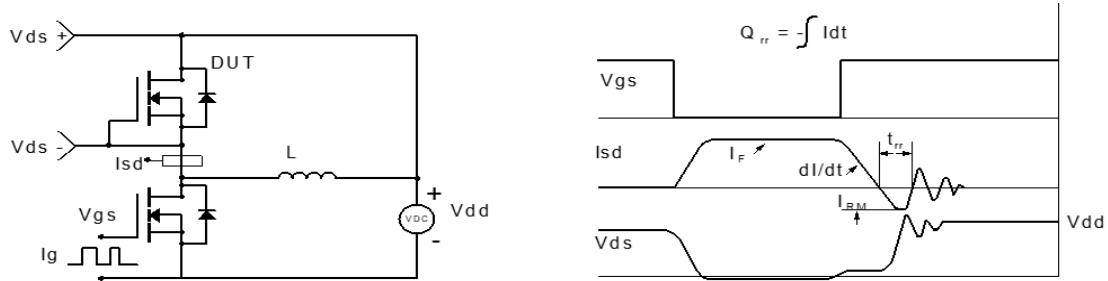
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**

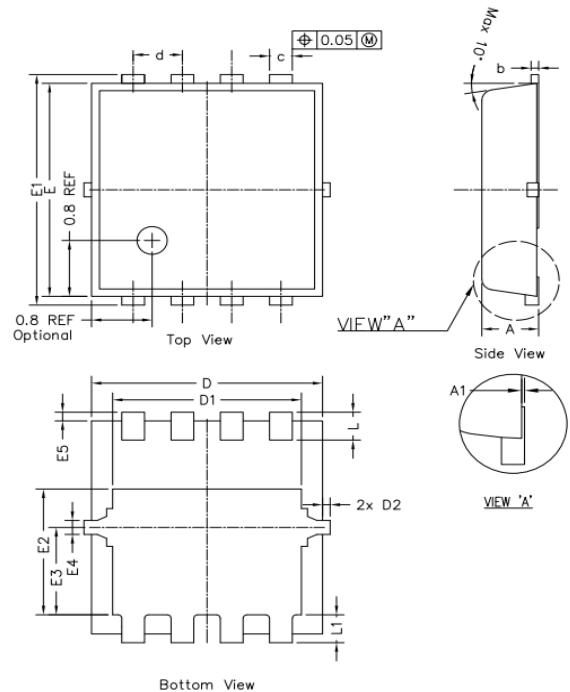


**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

## Package Mechanical Data(PDFN3x3-8L)



| SYMBOLS | DIMENSION IN MM |       |       | DIMENSION IN INCHES |       |       |
|---------|-----------------|-------|-------|---------------------|-------|-------|
|         | MIN             | NOM   | MAX   | MIN                 | NOM   | MAX   |
| A       | 0.700           | 0.750 | 0.800 | 0.028               | 0.030 | 0.031 |
| A1      | ---             | ---   | 0.050 | ----                | ----  | 0.002 |
| b       | 0.144           | 0.152 | 0.202 | 0.006               | 0.006 | 0.008 |
| c       | 0.250           | 0.300 | 0.350 | 0.010               | 0.012 | 0.014 |
| d       | 0.65 BSC        |       |       | 0.026 BSC           |       |       |
| D       | 2.950           | 3.050 | 3.150 | 0.116               | 0.120 | 0.124 |
| D1      | 2.390           | 2.490 | 2.590 | 0.094               | 0.098 | 0.102 |
| D2      | ---             | ---   | 0.125 | ---                 | ---   | 0.005 |
| E       | 2.950           | 3.050 | 3.150 | 0.116               | 0.120 | 0.124 |
| E1      | 3.200           | 3.300 | 3.400 | 0.126               | 0.130 | 0.134 |
| E2      | 1.700           | 1.800 | 1.900 | 0.067               | 0.071 | 0.075 |
| E3      | 1.150           | 1.250 | 1.350 | 0.045               | 0.049 | 0.053 |
| E4      | 0.150           | 0.200 | 0.250 | 0.006               | 0.008 | 0.010 |
| E5      | 0.075           | 0.125 | 0.175 | 0.003               | 0.005 | 0.007 |
| L       | 0.300           | 0.400 | 0.500 | 0.01                | 0.02  | 0.02  |
| L1      | 0.300           | 0.400 | 0.500 | 0.01                | 0.02  | 0.02  |

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